

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2582	257/E27.112.ccls.	US-PGPUB; USPAT	OR	ON	2006/11/27 12:01
L2	0	((semiconductor or wafer or substrate) and (insulator or SOI) and (oxide with (glass or glass\$ceramic)) and (positive with ion) and (enhanc\$4 with oxygen) and reduc\$3 and (modif\$4 with ion) and (alkaline with earth)).CLM.	US-PGPUB	OR	ON	2006/11/27 12:06
L3	0	((semiconductor or wafer or substrate) and (insulator or SOI) and (oxide with (glass or glass\$ceramic)) and (positive with ion) and (enhanc\$4 with oxygen) and reduc\$3 and (modif\$4 with ion)).CLM.	US-PGPUB	OR	ON	2006/11/27 12:07
L4	4	((semiconductor or wafer or substrate) and (insulator or SOI) and (oxide with (glass or glass\$ceramic)) and (positive with ion) and (enhanc\$4 with oxygen) and reduc\$3).CLM.	US-PGPUB	OR	ON	2006/11/27 12:07
S1	1625	(SOI or SOG or (silicon adj insulator) or (silicon adj glass)) and (bond with (energy or strength or stress))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 10:48
S2	344	S1 and SOG	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/20 14:32
S3	7	S2 and (glass adj ceramic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/20 14:32
S4	1383	(SOI or (silicon adj insulator) or (silicon adj glass)) and (bond with (energy or strength or stress))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/20 14:49

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S5	225	S4 and (silicon with oxide with glass)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:33
S6	14040	(anodic or electrostatic) with bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:56
S7	701	S6 and SOI	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:35
S8	552	S7 and silicon and glass	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:52
S9	0	S8 and sodium and lithium and calcium and magnesium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:35
S10	0	S8 and sodium and lithium and calcium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:36
S11	6	S8 and sodium and lithium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:36
S12	2	S8 and (alkaline with earth)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:45

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S13	77	S8 and (bond with strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:54
S14	0	S13 and joules	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:53
S15	3	S13 and Mpa	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:53
S16	991	((anodic or electrostatic) with bond\$3) and (bond with strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:57
S17	462	S16 and glass and (semiconductor or silicon or Si)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 18:01
S18	9	S17 and Joules	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:58
S19	26	S17 and (glass with silicon with strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 18:02
S20	510962	thermal expansion with glass	USPAT	OR	ON	2005/09/14 10:49
S21	14419	thermala expansion with glass	USPAT	OR	ON	2005/09/14 10:48
S22	9334	(thermal adj expansion) with glass	USPAT	OR	ON	2005/09/14 10:49
S23	4417	(coefficient adj thermal adj expansion) with glass	USPAT	OR	ON	2005/09/14 10:50
S24	2083	(coefficient adj thermal adj expansion) near2 glass	USPAT	OR	ON	2005/09/14 10:50

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S25	1856	S23 and silicon	USPAT	OR	ON	2005/09/14 10:50
S26	44	S25 and SOI	USPAT	OR	ON	2005/09/14 11:22
S27	4	(corning adj ("1737" or "1729" or "7740")) same resistivity	USPAT	OR	ON	2005/09/14 11:24
S28	2089	glass with resistivity	USPAT	OR	ON	2005/09/14 11:24
S29	4	(corning adj glass) with resistivity	USPAT	OR	ON	2005/09/14 11:26
S30	2089	glass with resistivity	USPAT	OR	ON	2005/09/14 11:26
S31	153	glass with resistivity with high with temperature	USPAT	OR	ON	2005/09/14 12:35
S32	1	("6048411").PN.	USPAT	OR	OFF	2006/01/29 15:31
S33	18	("4294602" "5374564" "5442205" "5559043" "5909627" "6048411" "6107653" "6140209" "6150239" "6211041" "6251754" "6309950" "6319867" "6323108" "6335231" "6391740" "6573126" "6593641").PN.	USPAT	OR	ON	2005/09/14 12:37
S34	2	("0033189" "6537938").PN.	USPAT	OR	ON	2005/09/14 12:37
S35	101	Henley.IN. and silicon	USPAT	OR	ON	2006/01/29 15:32
S36	44	S35 and implant\$5	USPAT	OR	ON	2006/01/29 15:32
S37	43	S36 and silicon\$on\$insulator	USPAT	OR	ON	2006/01/29 15:33
S38	27	S37 and (bonding with voltage)	USPAT	OR	ON	2006/01/29 15:33
S39	428	glass with fracture with strength	USPAT	OR	ON	2006/07/03 14:41
S40	0	S39 and joules\$meter	USPAT	OR	ON	2006/07/03 12:48
S41	12	S39 and joules	USPAT	OR	ON	2006/07/03 13:14
S42	125860	joules/("m.sup.2")	USPAT	OR	ON	2006/07/03 13:16
S43	108409	"m.sup.2"	USPAT	OR	ON	2006/07/03 13:16
S44	52940	S42 and glass	USPAT	OR	ON	2006/07/03 13:16
S45	141	S44 and (fracture adj strength)	USPAT	OR	ON	2006/07/03 13:18
S46	0	(bond adj strength) and joules/meter	USPAT	OR	ON	2006/07/03 13:20
S47	0	(bond adj strength) and joules\$meter	USPAT	OR	ON	2006/07/03 13:19
S48	252	(bond adj strength) and joules	USPAT	OR	ON	2006/07/03 13:19
S49	163	S48 and glass	USPAT	OR	ON	2006/07/03 13:19
S50	0	(bond adj strength) and (joules adj meter)	USPAT	OR	ON	2006/07/03 13:21
S51	0	joules\$meter and (bond adj strength)	USPAT	OR	ON	2006/07/03 13:24
S52	0	joules\$meter and (fracture adj strength)	USPAT	OR	ON	2006/07/03 13:25
S53	92	joules\$meter	USPAT	OR	ON	2006/07/03 13:29

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S54	0	joules\$meter2	USPAT	OR	ON	2006/07/03 13:30
S55	0	glass with toughness with joule	USPAT	OR	ON	2006/07/03 14:41
S56	1417	glass with toughness	USPAT	OR	ON	2006/07/03 14:48
S57	1	S56 and joule\$meter	USPAT	OR	ON	2006/07/03 14:42
S58	48	S56 and joule	USPAT	OR	ON	2006/07/03 14:42
S59	156	glass and (impact with toughness) and joule	USPAT	OR	ON	2006/07/03 14:52
S60	15	glass and (impact adj toughness) and joule	USPAT	OR	ON	2006/07/03 14:52
S61	1	("5854123").PN.	USPAT	OR	OFF	2006/07/21 10:07
S62	1314	438/455.ccls. or 257/E21.48.ccls.	US-PGPUB; USPAT	OR	ON	2006/11/27 09:52
S63	1046	((anodic or electrostatic) with bond\$3) and semiconductor and ((silicon with insulator) or SOI)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/27 09:54
S64	2	S63 and (modifier with ion)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/27 09:55
S65	1	S63 and (modifier with glass)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/27 09:55
S66	4710	257/347,E27.112.ccls.	US-PGPUB; USPAT	OR	ON	2006/11/27 10:11
S67	2812	257/347.ccls.	US-PGPUB; USPAT	OR	ON	2006/11/27 10:11